



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):	Tonapi, et al.	Docket:	136343 (1306-24)
Serial No.:	10/647,680	Examiner:	Not Yet Known
Filed:	August 25, 2003	Art Unit:	1714
For:	THIN BOND-LINE SILICONE ADHESIVE COMPOSITION AND METHOD FOR PREPARING THE SAME	Dated:	February 5, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CHANGE OF CORRESPONDENCE ADDRESS IN APPLICATION

Please send all future correspondence for this application to:

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Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope, addressed to the: Assistant Commissioner for Patents, Washington, D.C. 20231 on February 5, 2004.

Dated: February 5, 2004

Jennifer Vitale